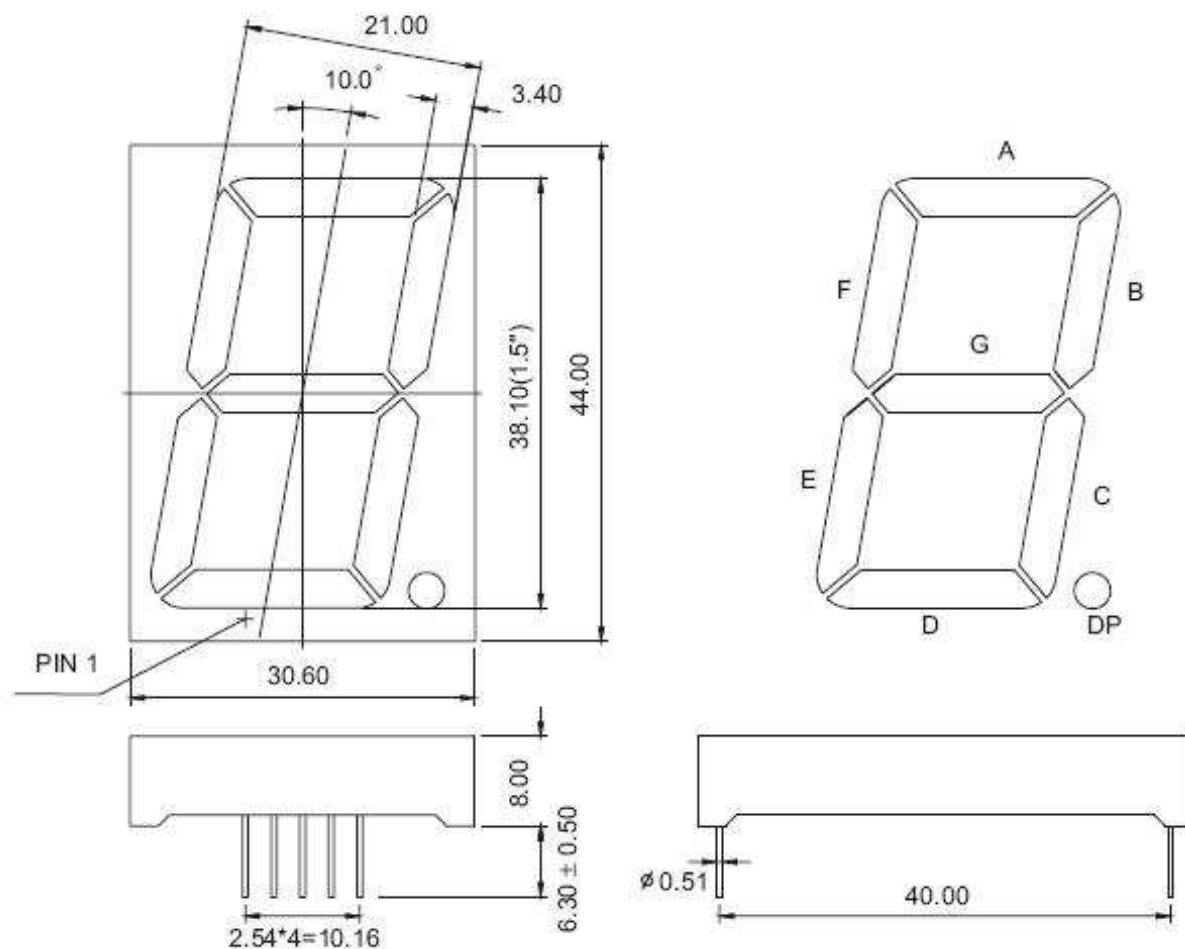


Characteristic	Test Condition	Symbol	R	HR	SR	O	Y	G	Units
Pulse Forward Current Per Seg.	1/10 duty cycle 0.1ms Pulse width	I_{FP}	50	100	100	100	100	100	mA
DC Forward Current Per Seg.		I_F	15	25	25	30	30	30	mA
Reverse Current Per Seg.	$V_R=10V$	I_R	10	10	10	10	10	10	μA
Power Dissipation		P_D	40*15	60*15	60*15	80*15	80*15	80*15	mW
Operating Temperature		T_{OPR}	-40 to +80						°C
Storage Temperature		T_{TSG}	-40 to +85						°C
Lead soldering temperature	1.60mm from body maximum 3 seconds		260						°C

1.50"(38.10mm)Single Digit 7 Segment Display

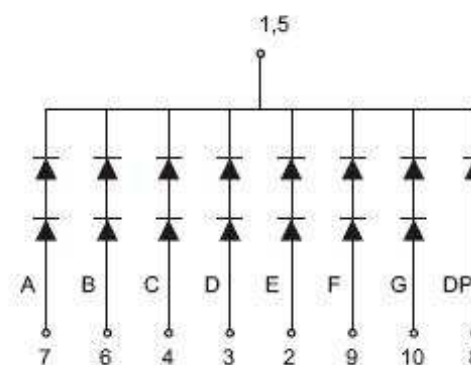
PACKAGE DIMENSION



Tolerance ± 0.25 mm unless stated

INTERNAL CIRCUIT DIAGRAM

Common Cathode
LD-S150X-CC



Common Anode
LD-S150X-C

